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# Fundamental consideration of junction formation strategies for phosphorus-doped emitters with $J_{0e} < 10 \text{ fA/cm}^2$

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## Abstract

This work shows the potential of further optimization of phosphorus-doped emitters in p-type silicon solar cells. We investigate the impact of different combinations of phosphorus doping profiles and surface passivation qualities on the saturation current density  $J_{0e}$  by considering boundary conditions based on published experimental data. Our simulation study shows that there are two possible ways to achieve  $J_{0e}$  values below  $10 \text{ fA/cm}^2$ . One is the reduction of the electrically active phosphorus concentration  $n_{\text{surf}}$  at the surface beneath  $2 \times 10^{19} \text{ cm}^{-3}$  and simultaneously reducing the surface recombination velocity  $S_p$  to below  $10^3 \text{ cm/s}$ . The other contrarily increases  $n_{\text{surf}}$  to values of up to  $1 \times 10^{21} \text{ cm}^{-3}$  while ensuring full activation of all phosphorus dopants. In the latter case,  $J_{0e}$  values below  $10 \text{ fA/cm}^2$  seem possible, even for  $S_p = 10^7 \text{ cm/s}$  which is equal to the thermal velocity.

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*Keywords:* emitter; recombination; passivation; junction formation

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## 1. Introduction

In past years, the record efficiency of industrial p-type solar cells has been increased steadily towards 22% and above by applying the passivated emitter and rear cell (PERC) technology with reduced saturation current density  $J_{0e}$  in the passivated emitter region. An excellent  $J_{0e}$  value near  $20 \text{ fA/cm}^2$  has been achieved with an industrial

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process sequence and industrial equipment for a PERC cell with an efficiency of 22.1% [1]. For future efficiency improvements, the recombination losses in the base and at the rear side need to be further reduced. However, this will increase the recombination losses in the emitter again since reduced recombination losses in the base and at rear side lead to higher excess carrier densities and consequently to higher maximum power point voltages [1, 2]. Consequently,  $J_{0e}$  has to be reduced further towards 10 fA/cm<sup>2</sup> as suggested in Ref. [2].

Which boundary conditions need to be fulfilled for such low  $J_{0e}$  values? In order to answer this question we investigate the impact of different combinations of doping profiles and surface passivation qualities on  $J_{0e}$  by means of state-of-the-art device modelling. To achieve  $J_{0e}$  below 10 fA/cm<sup>2</sup>, our modelling predicts two junction formation strategies. The electrically active Phosphorus concentration  $n_{\text{surf}}$  at the emitter surface has to be either reduced beneath  $2 \times 10^{19}$  cm<sup>-3</sup> or has to be increased up to  $1 \times 10^{21}$  cm<sup>-3</sup>. While the first approach requires excellent surface passivation quality with  $S_p$  values below 1000 cm/s, the second approach with  $n_{\text{surf}}$  near  $1 \times 10^{21}$  cm<sup>-3</sup> enables  $J_{0e}$  values below 10 fA/cm<sup>2</sup>, even for  $S_p$  equal to the thermal velocity, if phosphorus dopants are fully activated.

## 2. Approach

We investigate the recombination losses in phosphorus-doped emitters by simulating  $J_{0e}$  measurements with the device simulator SENTAURUS by applying most recent device models and silicon parameters [3, 4]. As doping profiles, we apply Gaussian profiles with varying surface doping concentration  $n_{\text{surf}}$  at constant sheet resistance  $R_{\text{sh}}$ . This is shown in Figure 1 exemplarily for  $R_{\text{sh}} = 120$  Ω/sq. In order to investigate the influence of  $R_{\text{sh}}$  on simulated  $J_{0e}$ , we consider the following two  $R_{\text{sh}}$  values: (i)  $R_{\text{sh}} = 120$  Ω/sq for representing the phosphorus-doped emitters of currently produced industrial solar cells with screen-printed fingers and busbars; (ii)  $R_{\text{sh}} = 380$  Ω/sq for solar cells with extremely low external series resistance due to advanced metallization techniques with advanced fine-line printing [2]. Furthermore, it is assumed that all dopant atoms are electrically active. At high doping concentration above  $n_{\text{surf}} = 4 \times 10^{20}$  cm<sup>-3</sup>, this assumption may not be valid for conventional POCl<sub>3</sub> diffusion process, but authors have reported full activation of the phosphorus atoms at carrier concentration of  $10^{21}$  cm<sup>-3</sup> using advanced chemical vapor deposition techniques [5, 6].

In addition, we vary the hole surface recombination velocity parameter for each Gaussian doping profile in order to analyze the impact of surface passivation quality on simulated  $J_{0e}$ .

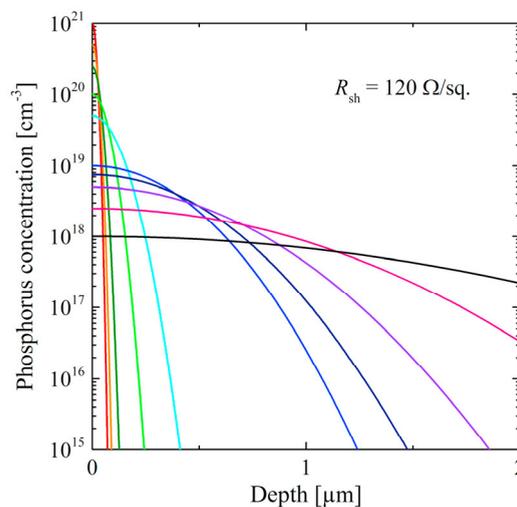


Fig. 1. Gaussian doping profiles with varying surface doping concentration  $n_{\text{surf}}$  at constant sheet resistance  $R_{\text{sh}} = 120$  Ω/sq.

### 3. Results

The simulated  $J_{0e}$  values are plotted as a function of  $n_{\text{surf}}$  by varying the surface recombination velocity parameter for holes  $S_p$  as shown in Fig. 2. By decreasing  $n_{\text{surf}}$ , the values of  $J_{0e}$  depend significantly on  $S_p$  while  $J_{0e}$  values at surface doping concentration near  $10^{21} \text{ cm}^{-3}$  are nearly independent of  $S_p$ . Fig. 2(a) shows that  $J_{0e}$  values below  $10 \text{ fA/cm}^2$  can be achieved with  $R_{\text{sh}} = 120 \text{ } \Omega/\text{sq}$  for following conditions: (i) for  $n_{\text{surf}} < 2 \times 10^{19} \text{ cm}^{-3}$ , the value of  $S_p$  needs to be similar to or lower than  $10^2 \text{ cm/s}$ ; (ii) for  $n_{\text{surf}} > 5 \times 10^{20} \text{ cm}^{-3}$ , the value of  $S_p$  can vary between 1 and  $10^7 \text{ cm/s}$  depending on  $n_{\text{surf}}$ .

In contrast,  $R_{\text{sh}} = 380 \text{ } \Omega/\text{sq}$  allows  $J_{0e}$  values below  $10 \text{ fA/cm}^2$  for any  $n_{\text{surf}}$  in the investigated range, if  $S_p$  can be kept below  $100 \text{ cm/s}$  as shown in Fig. 2(b). The reason is a decrease in the Auger recombination with increasing  $R_{\text{sh}}$  following from the reduced amount of phosphorus donors in the emitter. Unfortunately, it is well known in the literature that  $S_p$  depends strongly on  $n_{\text{surf}}$ , a subject which will be discussed in the next section.

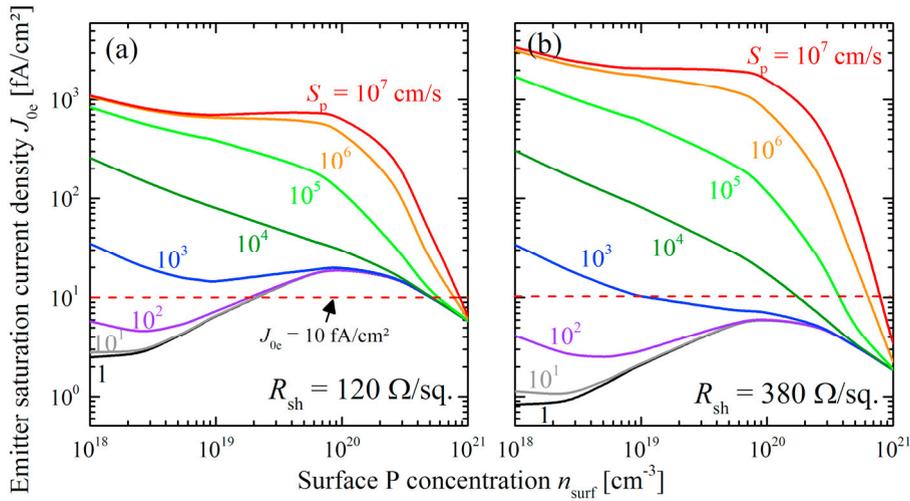


Fig. 2. Simulated  $J_{0e}$  values of Gaussian profiles with varying  $n_{\text{surf}}$ . The sheet resistance value was kept constant with (a)  $R_{\text{sh}} = 120 \text{ } \Omega/\text{sq}$  and (b)  $R_{\text{sh}} = 380 \text{ } \Omega/\text{sq}$ . The  $J_{0e}$  value of  $10 \text{ fA/cm}^2$  is marked with a red dashed line.

### 4. Discussions

In our simulation study, we assumed that  $S_p$  values are independent of  $n_{\text{surf}}$ . However, it is shown experimentally that  $S_p$  increases monotonically towards high  $n_{\text{surf}}$ , regardless of which type of surface passivation has been applied as shown in Fig. 3(a).

By reviewing the measured  $S_p$  values of textured surfaces from literature (see Fig. 3a), we find the following correlation between  $S_p$  and  $n_{\text{surf}}$  for passivated emitters on textured surfaces: (i)  $S_p$  values below  $10^3 \text{ cm/s}$  have so far not been reported for  $n_{\text{surf}}$  above  $1 \times 10^{19} \text{ cm}^{-3}$ ; (ii)  $S_p$  values reach nearly  $10^6 \text{ cm/s}$  at  $n_{\text{surf}}$  near  $2 \times 10^{20} \text{ cm}^{-3}$ . Therefore, only the simulated  $J_{0e}$  values with  $S_p = 10^7 \text{ cm/s}$  are meaningful at  $n_{\text{surf}}$  near  $1 \times 10^{21} \text{ cm}^{-3}$ . Consequently, we derive the following two strategies that allow  $J_{0e}$  values below  $10 \text{ fA/cm}^2$  for both considered  $R_{\text{sh}}$  values. First,  $n_{\text{surf}}$  has to be reduced beneath  $2 \times 10^{19} \text{ cm}^{-3}$  and simultaneously the value of  $S_p$  needs to be similar to or lower than  $100 \text{ cm/s}$ . Alternatively,  $n_{\text{surf}}$  is increased up to  $1 \times 10^{21} \text{ cm}^{-3}$ . In this case,  $J_{0e}$  values below  $10 \text{ fA/cm}^2$  are possible, even for  $S_p = 10^7 \text{ cm/s}$  because the hole concentration at the surface is strongly suppressed. This can be explained by the increased effect of Pauli-blocking at high donor concentration  $N_D$  that leads to the exponential decrease of hole concentration for  $N_D$  above  $1 \times 10^{20} \text{ cm}^{-3}$  as shown in Fig. 3(b).

The first approach with reduced  $n_{\text{surf}}$  is the common method that is currently applied in the PV community [7]. The reduction of  $n_{\text{surf}}$  beneath  $2 \times 10^{19} \text{ cm}^{-3}$  can be realized with an etch back process after conventional  $\text{POCl}_3$  diffusion or with advanced  $\text{POCl}_3$  diffusion processes such as diluted source or low pressure diffusion technology.

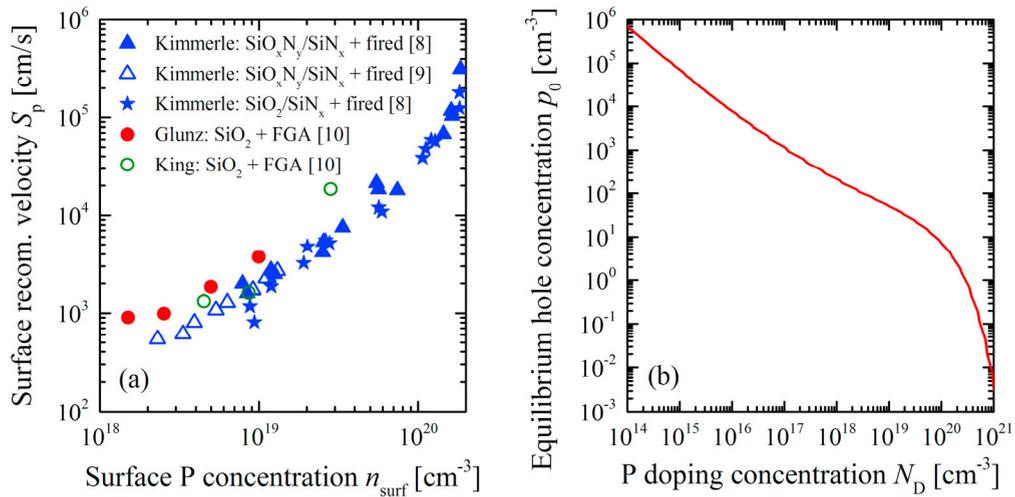


Fig. 3. (a) Surface recombination velocity plotted versus the electrically active Phosphorus concentration at textured surface for SiO $_x$ N $_y$ /SiN $_x$  (triangles), SiO $_2$ /SiN $_x$  (stars) and SiO $_2$  (circles) passivated emitters. The values are extracted from various authors in Refs. [8-10]; (b) Equilibrium hole concentration  $p_0$  as a function of the electrically active phosphorus doping concentration  $N_D$ .

However, the technical implementation of  $S_p$  values near  $10^2$  cm/s may be the major challenge, since the reported  $S_p$  values on textured emitter surfaces seem to saturate towards  $10^3$  cm/s for  $n_{surf}$  below  $1 \times 10^{19}$  cm $^{-3}$  as shown in Fig. 3(a). An aluminum anneal may be a suitable candidate to realize such extremely low  $S_p$  values on textured emitter surfaces, since it allows generally lower  $S_p$  values compared to the passivation layers listed in Fig. 3(a) [10].

By contrast, the major challenge for the second approach with  $n_{surf}$  near  $1 \times 10^{21}$  cm $^{-3}$  is the technical implementation of heavily-doped layers without electrically inactive dopants and process-induced defects. Advanced chemical vapor deposition (CVD) techniques such as photo-CVD or plasma-CVD appear to be most promising processes for its realization as demonstrated in Refs. [5, 6]. Since these kinds of heavily-doped emitters possess a great potential to reduce  $J_{0e}$  significantly, its recombination properties deserve deeper investigations. In addition, the silicon properties such as band-gap narrowing or mobility of holes at doping concentration near  $1 \times 10^{21}$  cm $^{-3}$  should be investigated further in order to validate the simulation results in this study.

Nevertheless, heavily-doped emitters with  $n_{surf}$  near  $1 \times 10^{21}$  cm $^{-3}$  seem to be very charming for solar cell applications, since it might allow extremely low  $J_{0e}$  values that are nearly independent of the surface passivation quality, because the minority carrier concentration is strongly suppressed in this region. Therefore, solar cells featuring such heavily-doped emitters might be resistant to ultraviolet degradation of surface passivation. Furthermore, it is possible to neglect the introduction of passivating buffer layers between the silicon and the metal contacts, since the  $J_{0e}$  values are below 10 fA/cm $^2$ , even if setting  $S_p$  equal to the thermal velocity.

## 5. Summary

In this paper we identify the fundamental junction formation strategies for further improvements of phosphorus-doped emitters in p-type silicon solar cells. Our simulation study shows that the electrically active phosphorus concentration  $n_{surf}$  at the surface is the decisive parameter for controlling emitter recombination losses, if the full activation of phosphorus dopants is ensured. Therefore  $n_{surf}$  should be either reduced beneath  $2 \times 10^{19}$  cm $^{-3}$  while ensuring excellent surface passivation quality or increased up to  $1 \times 10^{21}$  cm $^{-3}$ . On the one hand, our study validates the common method of the emitter optimization by reducing  $n_{surf}$  and shows boundary conditions for its realization. On the other hand, our study may give a new direction for further optimization featuring heavily-doped emitters with  $n_{surf}$  near  $1 \times 10^{21}$  cm $^{-3}$ .

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